

## F7410-VB Datasheet

### P-Channel 12-V (D-S) MOSFET

#### PRODUCT SUMMARY

$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
- 12	0.0050 at $V_{GS} = - 4.5$ V	- 16
	0.0065 at $V_{GS} = - 2.5$ V	- 15
	0.0100 at $V_{GS} = - 1.8$ V	- 13

#### FEATURES

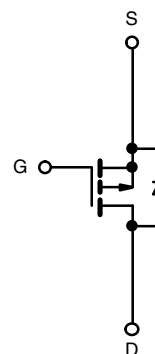
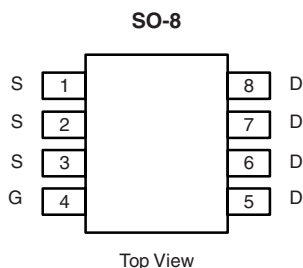
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Load Switch
- Battery Switch



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available



P-Channel MOSFET

#### ABSOLUTE MAXIMUM RATINGS $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	- 12		V
Gate-Source Voltage		$V_{GS}$	$\pm$ 8		
Continuous Drain Current ( $T_J = 150\text{ }^{\circ}\text{C}$ ) <sup>a</sup>	$T_A = 25\text{ }^{\circ}\text{C}$	$I_D$	- 16	- 10	A
	$T_A = 70\text{ }^{\circ}\text{C}$		- 11.5	- 8	
Pulsed Drain Current		$I_{DM}$	- 50		
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	- 2.7	- 1.36	W
Maximum Power Dissipation <sup>a</sup>	$T_A = 25\text{ }^{\circ}\text{C}$	$P_D$	3.0	1.5	
	$T_A = 70\text{ }^{\circ}\text{C}$		1.9	0.95	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to 150		$^{\circ}\text{C}$

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	33	42	$^{\circ}\text{C/W}$
		70	84	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	16	21	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

**SPECIFICATIONS**  $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted

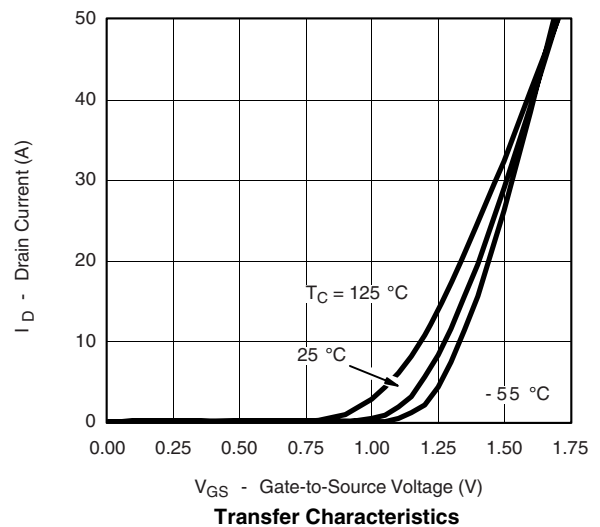
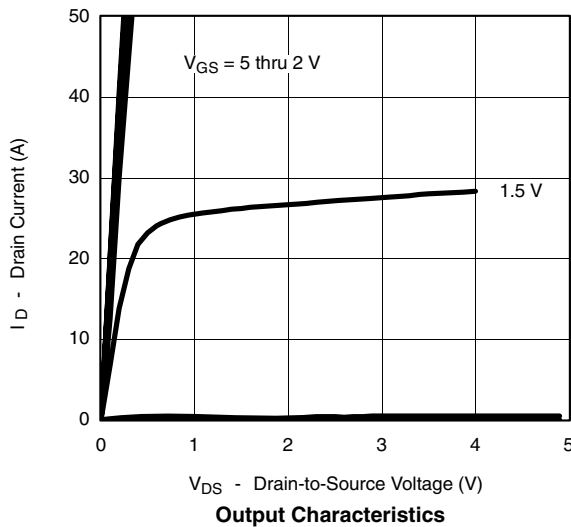
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -600\text{ }\mu\text{A}$	-0.5	-	1.0	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -12\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -12\text{ V}, V_{GS} = 0\text{ V}, T_J = 70\text{ }^{\circ}\text{C}$			-10	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = -5\text{ V}, V_{GS} = -4.5\text{ V}$	-30			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -14\text{ A}$		0.0050		$\Omega$
		$V_{GS} = -2.5\text{ V}, I_D = -13\text{ A}$		0.0065		
		$V_{GS} = -1.8\text{ V}, I_D = -12\text{ A}$		0.0100		
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -6\text{ V}, I_D = -14\text{ A}$		80		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -2.7\text{ A}, V_{GS} = 0\text{ V}$		-0.6	-1.1	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = -6\text{ V}, V_{GS} = -5\text{ V}, I_D = -14\text{ A}$		110	165	nC
Gate-Source Charge	$Q_{gs}$			15		
Gate-Drain Charge	$Q_{gd}$			27.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, R_L = 6\text{ }\Omega$ $I_D \approx -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 6\text{ }\Omega$		110	170	ns
Rise Time	$t_r$			235	350	
Turn-Off Delay Time	$t_{d(off)}$			410	620	
Fall Time	$t_f$			285	430	
Gate Resistance	$R_g$			3.6		$\Omega$
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = -2.1\text{ A}, dI/dt = 100\text{ A}/\mu\text{s}$		180	270	ns

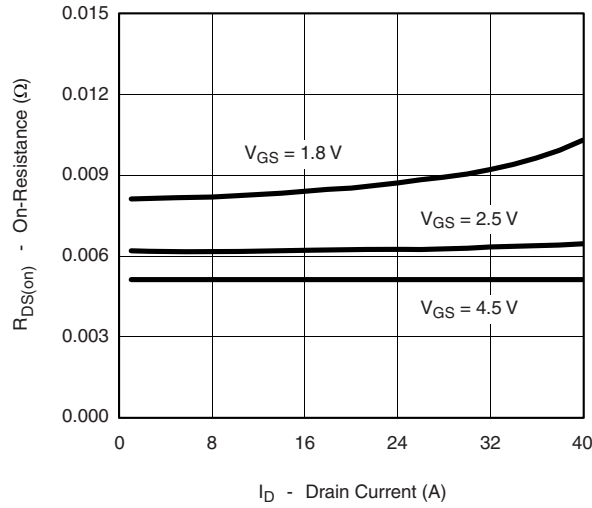
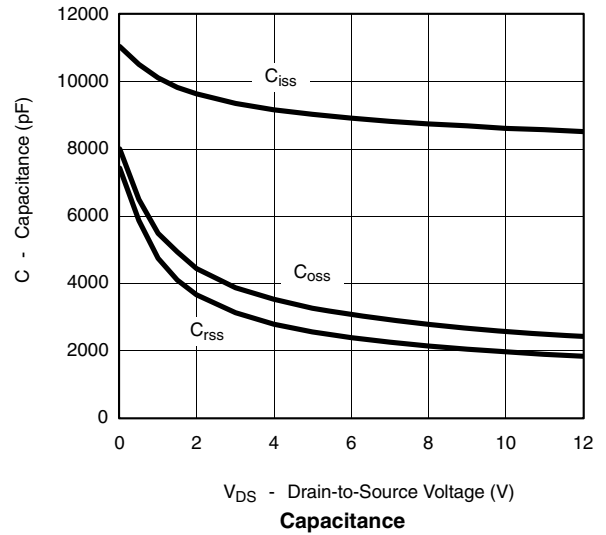
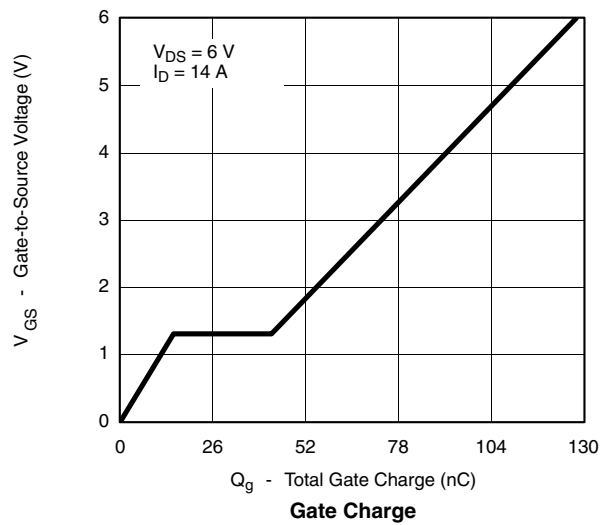
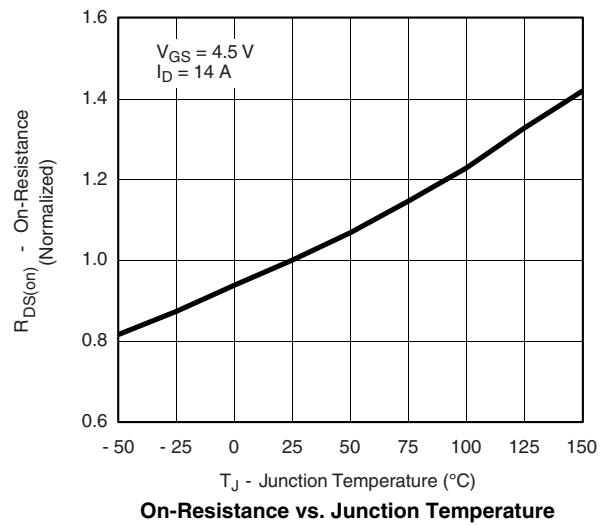
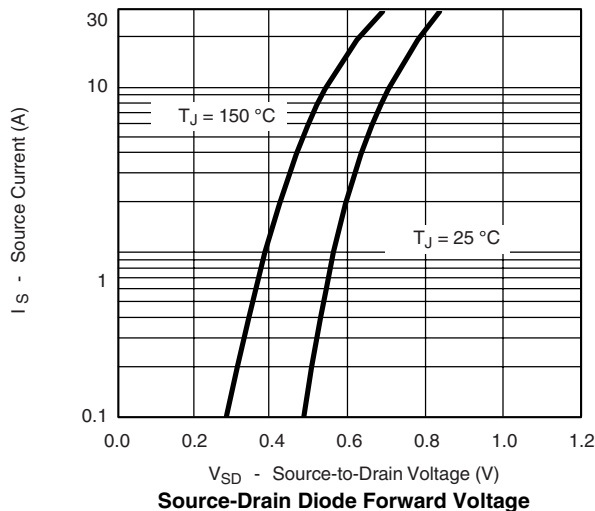
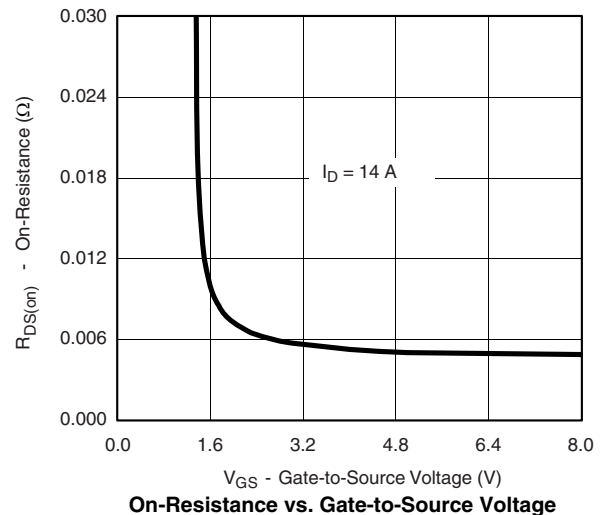
Notes:

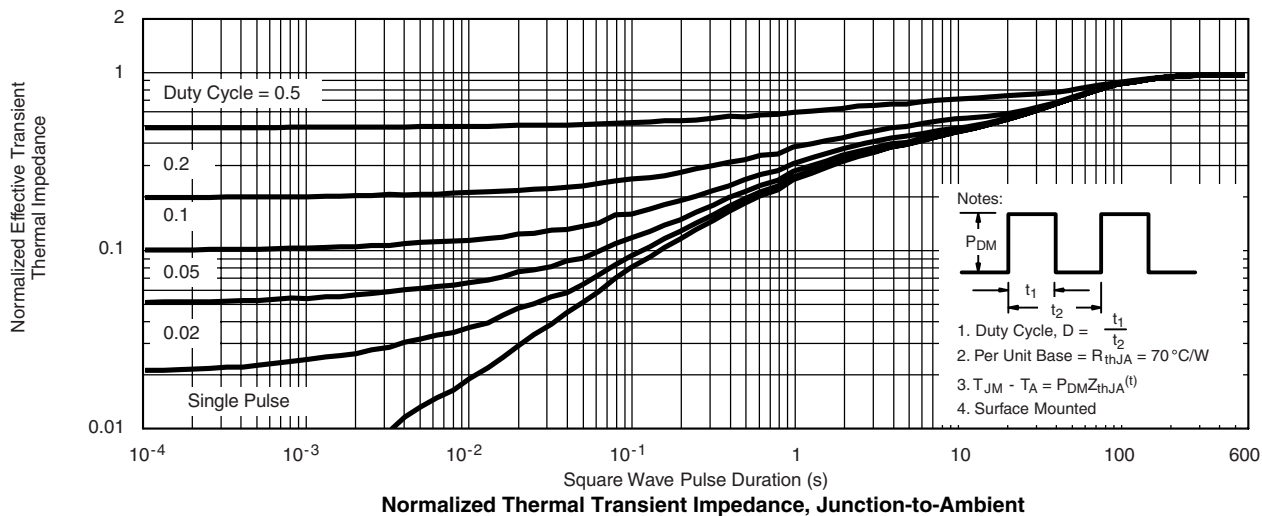
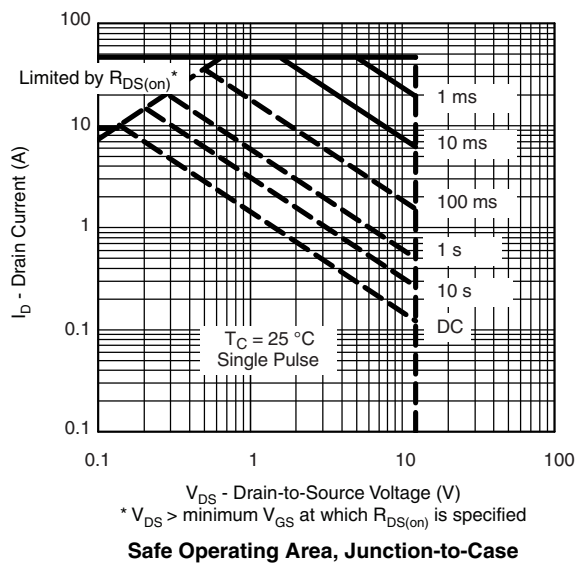
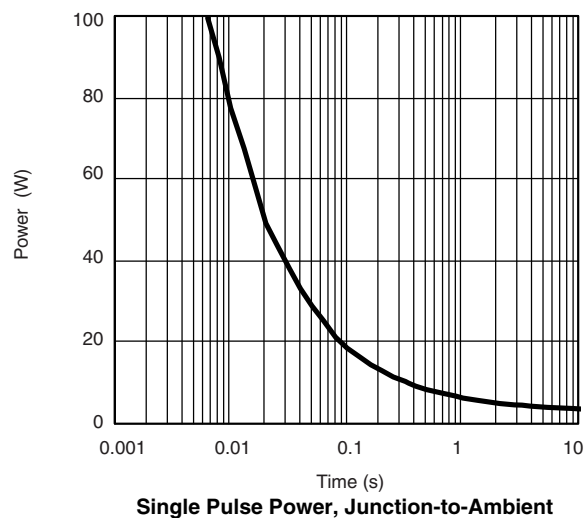
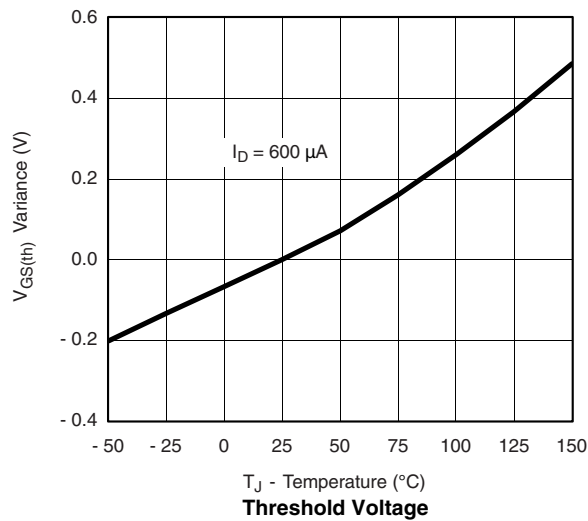
a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

b. Guaranteed by design, not subject to production testing.

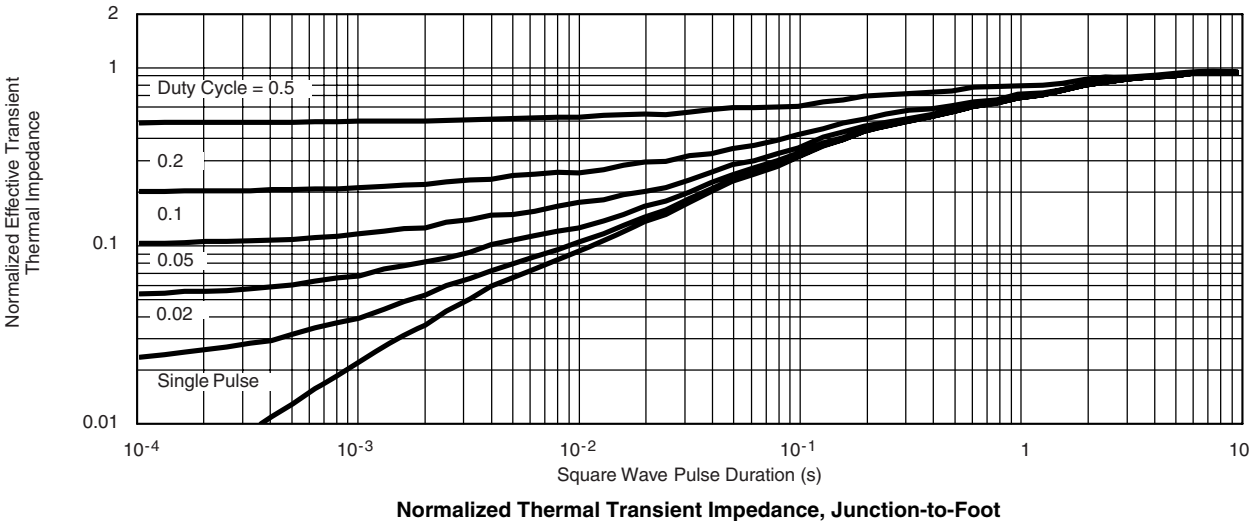
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS**  $25\text{ }^{\circ}\text{C}$  unless otherwise noted

**TYPICAL CHARACTERISTICS** 25 °C unless otherwise noted

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**TYPICAL CHARACTERISTICS** 25 °C unless otherwise noted


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